

SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

N-Channel Silicon MOSFET

ECH8419 — General-Purpose Switching Device Applications

Features

- ON-resistance RDS(on)1=13m Ω (typ.)
- · 4V drive
- · Halogen free compliance
- · Protection diode in

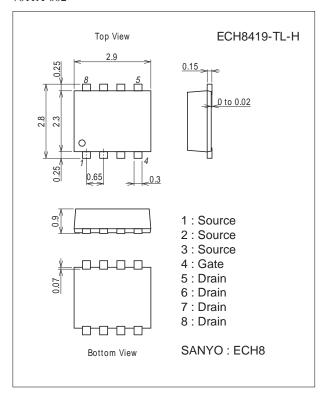
Specifications

Absolute Maximum Ratings at Ta=25°C

| Parameter | Symbol | Conditions | Ratings | Unit |
|-----------------------------|--------|---|-------------|------|
| Drain-to-Source Voltage | VDSS | | 35 | V |
| Gate-to-Source Voltage | VGSS | | ±20 | V |
| Drain Current (DC) | ID | | 9 | Α |
| Drain Current (Pulse) | IDP | PW≤10μs, duty cycle≤1% | 40 | А |
| Allowable Power Dissipation | PD | When mounted on ceramic substrate (900mm ² ×0.8mm) | 1.5 | W |
| Channel Temperature | Tch | | 150 | C |
| Storage Temperature | Tstg | | -55 to +150 | C |

Package Dimensions

unit : mm (typ) 7011A-002



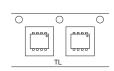
Product & Package Information

• Package : ECH8

• JEITA, JEDEC :-

• Minimum Packing Quantity : 3,000 pcs./reel

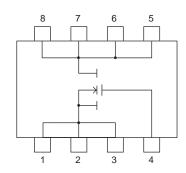
Packing Type : TL





Marking

Electrical Connection

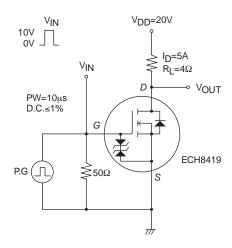


ECH8419

Electrical Characteristics at Ta=25°C

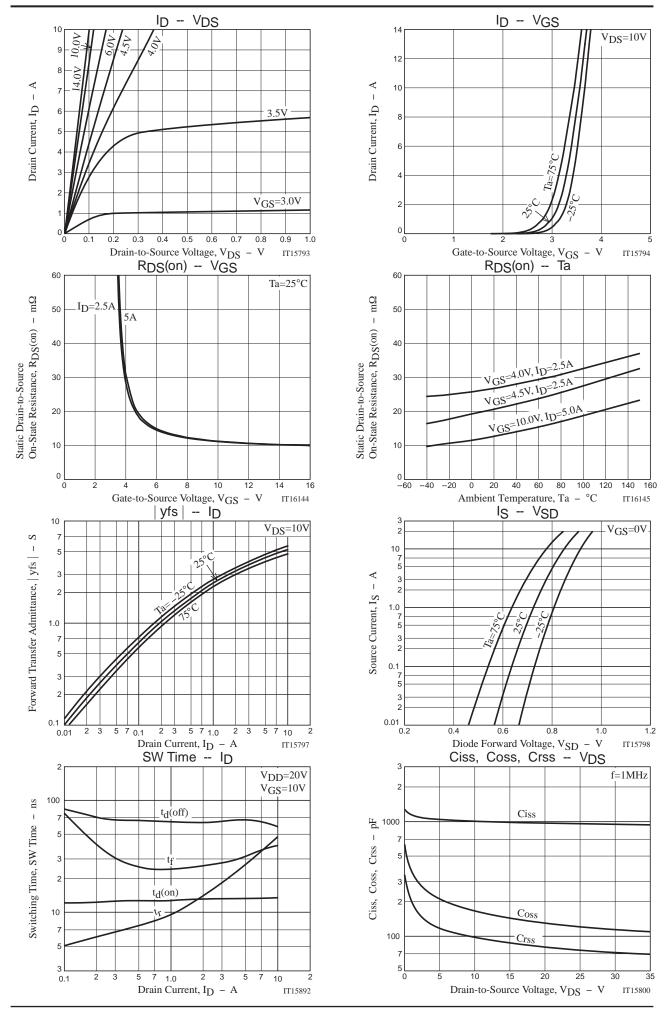
| Parameter | Cumphial | Conditions | Ratings | | | Unit | |
|--|-----------------------|--|---------|------|-----|-----------|--|
| Parameter | Symbol | Conditions | min | typ | max | Onit | |
| Drain-to-Source Breakdown Voltage | V(BR)DSS | ID=1mA, VGS=0V | 35 | | | V | |
| Zero-Gate Voltage Drain Current | IDSS | V _{DS} =35V, V _{GS} =0V | | | 1 | μΑ | |
| Gate-to-Source Leakage Current | IGSS | V _{GS} =±16V, V _{DS} =0V | | | ±10 | μΑ | |
| Cutoff Voltage | VGS(off) | V _{DS} =10V, I _D =1mA | 1.2 | | 2.6 | V | |
| Forward Transfer Admittance | yfs | V _D S=10V, I _D =5A | | 4.3 | | S | |
| | R _{DS} (on)1 | I _D =5A, V _G S=10V | | | 17 | $m\Omega$ | |
| Static Drain-to-Source On-State Resistance | R _{DS} (on)2 | I _D =2.5A, V _G S=4.5V | | 21 | 30 | $m\Omega$ | |
| | R _{DS} (on)3 | I _D =2.5A, V _G S=4V | | 27 | 38 | mΩ | |
| Input Capacitance | Ciss | | | 960 | | pF | |
| Output Capacitance | Coss | VDS=20V, f=1MHz | | 130 | | pF | |
| Reverse Transfer Capacitance | Crss | | | 80 | | pF | |
| Turn-ON Delay Time | t _d (on) | | | 13 | | ns | |
| Rise Time | t _r | Can appairing Test Circuit | | 26 | | ns | |
| Turn-OFF Delay Time | t _d (off) | See specified Test Circuit. | | 66 | | ns | |
| Fall Time | tf | | | 31 | | ns | |
| Total Gate Charge | Qg | | | 19 | | nC | |
| Gate-to-Source Charge | Qgs | V _{DS} =20V, V _{GS} =10V, I _D =9A | | 3.9 | | nC | |
| Gate-to-Drain "Miller" Charge | Qgd |] | | 3.8 | | nC | |
| Diode Forward Voltage | V _{SD} | I _S =9A, V _{GS} =0V | | 0.85 | 1.2 | V | |

Switching Time Test Circuit

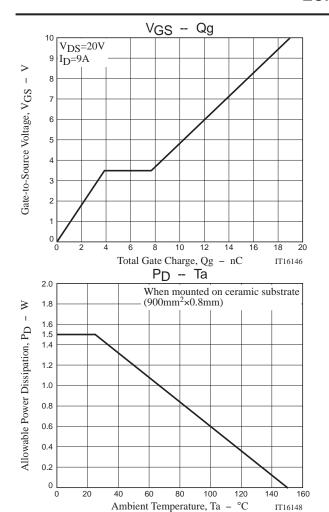


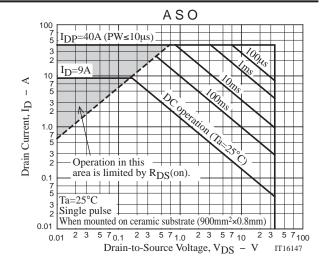
Ordering Information

| Device | Package | Shipping | memo | |
|--------------|------------------|----------|--------------------------|--|
| ECH8419-TL-H | CH8419-TL-H ECH8 | | Pb Free and Halogen Free | |



ECH8419



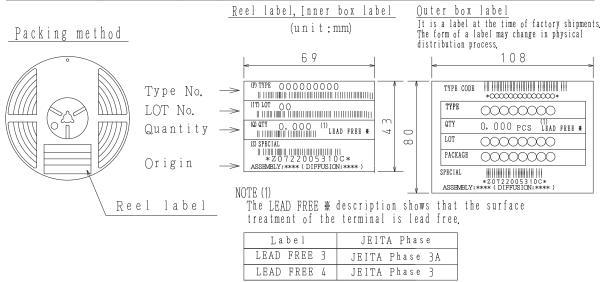


Embossed Taping Specification

ECH8419-TL-H

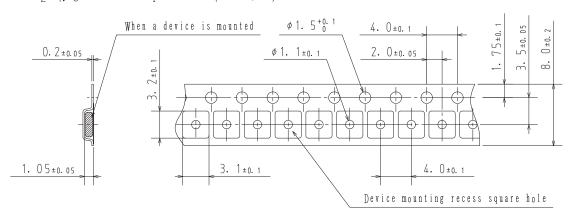
1. Packing Format

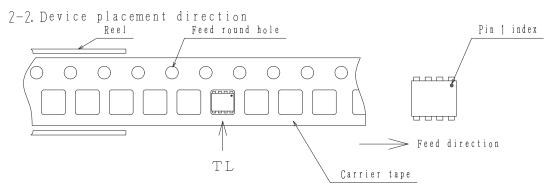
| Package Name | Carrier Tape | Maximum Number of devices contained (pcs) | | | Packing | format |
|--------------|--------------|--|-----------|-----------|--------------------------|--------------------------|
| | Туре | Reel | Inner box | Outer box | Inner $BOX(C-1)$ | Outer BOX (A-7) |
| ECH8 | СРН6 | 3, 000 | 15, 000 | 90,000 | 5 reels contained | 6 inner boxes contained |
| | | | | | Dimensions:mm (external) | Dimensions:mm (external) |
| | | | | | 183×72×185 | 440×195×210 |



2. Taping configuration

2-1. Carrier tape size (unit:mm)





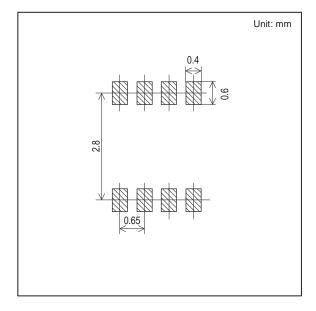
Those with pin 1 index on the feed hole side · · · · · TL

Outline Drawing

ECH8419-TL-H

Mass (g) Unit 0.02 For reference mm 2. 9±0.06 8 7 6 5 LOT No. PIN\$11 2. 9±0.05 3. 1±0.05 3.

Land Pattern Example



Note on usage: Since the ECH8419 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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